# PATENT ASSIGNMENT

# Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

### **CONVEYING PARTY DATA**

Name	Execution Date
Stephen W. Bedell	02/23/2011
Bahman Hekmatshoartabari	02/23/2011
Alexander Reznicek	02/23/2011
Devendra K. Sadana	02/23/2011
Ghavam G. Shahidi	02/28/2011
Davood Shahrjerdi	02/23/2011

### **RECEIVING PARTY DATA**

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#### PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13037944

### **CORRESPONDENCE DATA**

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ATTORNEY DOCKET NUMBER:	YOR920110087US2
NAME OF SUBMITTER:	Paul J. Otterstedt
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REEL: 025881 FRAME: 0204 501452930

Total Attachments: 3

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PATENT REEL: 025881 FRAME: 0205 IBM DOCKET NUMBER: YOR920110087US2

# **ASSIGNMENT**

Whereas, the undersigned Inventor(s) has/have made certain inventions, improvements, and discoveries (herein referred to as the "Invention") in:

Title of the Invention: GROWING COMPRESSIVELY STRAINED SILICON DIRECTLY
ON SILICON AT LOW TEMPERATURES

and further identified by the IBM Docket Number provided above in the header of this Assignment, for

which an application for a United States Patent	was executed concurrently herewith or was filed having:
Application No.: 13/037,944	(insert series code/serial number here if/when available)
business at Armonk, New York (herein referred	oration, a corporation of New York having a place of to as "IBM"), desires to acquire, and each undersigned dwide right, title, and interest in and to the Invention and ents directed thereto;

Now, therefore, for good and valuable consideration, the receipt and sufficiency thereof being hereby acknowledged, each undersigned inventor ("ASSIGNOR") hereby sells, assigns, and otherwise transfers to IBM (the "ASSIONEE"), its successors, legal representatives, and assigns, the entire worldwide right, title, and interest in and to the Invention, the above-identified United States patent application, and any and all other patent applications and patents for the invention which may be applied for or granted therefor in the United States and in all foreign countries and jurisdictions, including all divisions, continuations, reissues, reexaminations, renewals, extensions, counterparts, substitutes, and extensions thereof, and all rights of priority resulting from the filing of such applications and granting of such patents. In addition, each undersigned Inventor hereby suthorizes and requests the Director of the United States Patent and Trademark Office to issue any United States Patent, and foreign patent authorities to issue any foreign patent, granted for the Invention, to IBM, its successors, legal representatives, and assigns, the entire worldwide right, title, and interest in and to the same to be held and enjoyed by IBM. its successors, legal representatives, and assigns to the full end of the terms for which any and all such patents may be granted, as fully and entirely as would have been held and enjoyed by the undersigned had this Assignment not been made; and each undersigned Inventor agrees to execute any and all documents and instruments and perform all lawful acts reasonably related to recording this Assignment or perfecting title to the invention and all related patents and applications, in IBM, its successors, legal representatives, and assigns, whenever requested by IBM, its successors, legal representatives, or assigns.

Each undersigned Inventor acknowledges their prior and ongoing obligations to sell, assign, and transfer the rights under this Assignment to IBM and is unaware of any reason why they may not have the full and unancumbered right to sell, assign, and transfer the rights hereby sold, assigned, and transferred, and has not executed, and will not execute, any document or instrument in conflict herewith. Each undersigned inventor also hereby grants IBM, its successors, legal representatives, and assigns, the right to insert in this Assignment any further identification (including, but not limited to, patent Application Number) which may be necessary or desirable for recordation of this Assignment. This Assignment is governed by the substantive laws of the State of New York, and any disputes will be resolved in a New York state court or federal court sited in New York.

[Inventor Signature Page(s) Follows]

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Assignment Form.Rev2 (Updated 08/07/2009)

# IBM DOCKET NUMBER: YOR920110087US2

Executed by Inventor 1		
Signature: Date: 02/23/201/ Stephen W. Bedell		
Executed by Inventor 2		
Signature:Date:Date:Date:		
Executed by Inventor 3		
Signature: Date: 02/23/2011 Alexander Reznicek		
Executed by Inventor 4		
Signature: Devendra K. Sadana  Executed by Inventor 5		
Signature: U(4) 4 5(1) Ghavam G. Shahidi Date: 2/28/241		

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# IBM DOCKET NUMBER: YÖR920110087US2

Executed by Inventor 6	
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Signature: Day 154 Shaha i a Q Date: Q	2123120U
Davood Shahrjerdi	

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**RECORDED: 03/01/2011** 

PATENT REEL: 025881 FRAME: 0208